



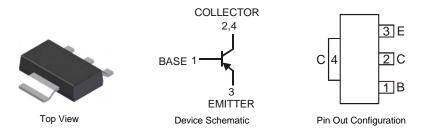
#### SOT223 PNP SILICON PLANAR HIGH PERFORMANCE TRANSISTOR

#### **Features**

- V<sub>CEO</sub> = 60V
- Continuous current I<sub>C(cont)</sub> = 3A
- Low Saturation Voltage
- Complementary Type FZT651

#### **Mechanical Data**

- Case: SOT-223
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.112 grams (approximate)

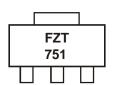


### **Ordering Information**

Product	Product Marking		Tape width (mm)	Quantity per reel	
FZT751TA	FZT751	7	12	1000	
FZT751-7 (Note 1)	FZT751	7	12	1000	

Notes: 1. "Green" version.

## **Marking Information**



FZT751 = Product type Marking Code





# **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-80	V
Collector-Emitter Voltage	$V_{CEO}$	-60	V
Emitter-Base Voltage	$V_{EBO}$	-5	V
Continuous Collector Current	Ic	-3	Α
Peak Pulse Current	I <sub>CM</sub>	-6	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation at T <sub>A</sub> = 25°C	$P_{D}$	2	W
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-55 to +150	°C

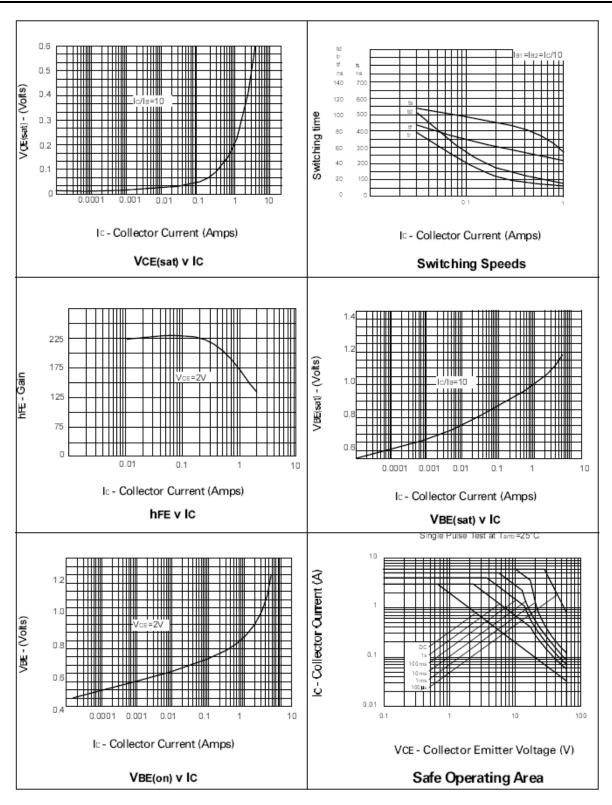
### Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	-80	-	-	V	$I_C = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 2)	$V_{(BR)CEO}$	-60	_	-	V	$I_C = -10 \text{mA}$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	-5	_	_	V	$I_E = 100\mu A$
Collector Cut-off Current	I <sub>CBO</sub>	_ _	_ _	-0.1 -10	μA μA	$V_{CB} = -60V$ $V_{CB} = -60V$ , $T_{amb} = 100$ °C
Emitter Cut-off Current	I <sub>EBO</sub>	_	_	-0.1	. μA	$V_{EB} = -4V$
Collector-Emitter Saturation Voltage (Note 2)	V <sub>CE(SAT)</sub>	_ _	-0.15 -0.45	0.3 0.6	V	$I_C = -1A$ , $I_B = -100$ mA $I_C = -3A$ , $I_B = -300$ mA
Base-Emitter Saturation Voltage (Note 2)	V <sub>CE(SAT)</sub>	-	-0.9	-1.25	V	$I_C = -1A$ , $I_B = -100mA$
Base-Emitter Turn-On Voltage (Note 2)	$V_{BE(ON)}$	-	-0.8	-1.0	mV	$I_C = -1A$ , $V_{CE} = -2V$
DC Current Gain (Note 2)	h <sub>FE</sub>	70 100 80 40	200 200 170 150	- 300 - -		$\begin{split} &I_{C} = \text{-50mA, V}_{CE} = \text{-2V} \\ &I_{C} = \text{-500mA, V}_{CE} = \text{-2V} \\ &I_{C} = \text{-1A, V}_{CE} = \text{-2V} \\ &I_{C} = \text{-2A, V}_{CE} = \text{-2V} \end{split}$
Current Gain-Bandwidth Product (Note 2)	f⊤	100	140	=	MHz	$V_{CE} = -5V, I_{C} = -100mA$ f = 100MHz
Turn-On Time	t <sub>on</sub>	_	40	-	nA	$V_{CC} = -10V, I_{C} = -500mA$
Turn-Off Time	$t_{off}$	_	450	_	nA	$I_{B1} = I_{B2} = -50 \text{mA}$
Output Capacitance (Note 2)	$C_{obo}$	-	-	30	pF	V <sub>CB</sub> = -10V. f = 1MHz

Notes: 2. Measured under pulsed conditions. Pulse width =  $300 \mu s$ . Duty cycle  $\leq 2\%$ 

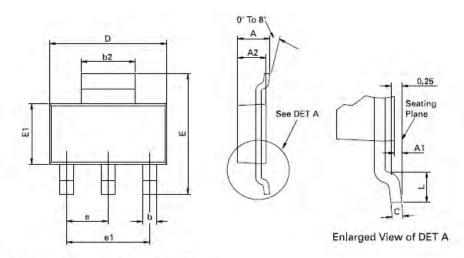


## **Typical Characteristics**





## **Package Outline Dimensions**

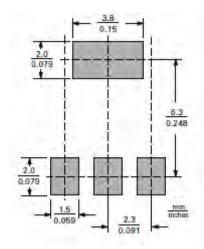


Conforms to JEDEC TO-261 AA Issue B

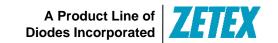
Dim.	Millimeters		Inches		Dim.	Millimeters		Inches	
	Min.	Max.	Min.	Max.	Dim.	Min.	Max.	Min.	Max.
Α		1.80	1 2	0.071	D	6.30	6.70	0.248	0.264
A1	0.02	0.10	0.0008	0.004	е	2.30 BSC		0.0905 BSC	
A2	1.55	1.65	0.0610	0.0649	e1	4.60 BSC		0.181 BSC	
b	0.66	0.84	0.026	0.033	E	6.70	7.30	0.264	0.287
b2	2.90	3.10	0.114	0.122	E1	3.30	3.70	0.130	0.146
С	0.23	0.33	0.009	0.013	L	0.90		0.035	3-11

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

# Suggested Pad Layout







#### **IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices-or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2010, Diodes Incorporated

www.diodes.com